

• General Description

The AGM18N20H combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{\text{DS(ON)}}$.

This device is ideal for load switch and battery protection applications.

Features

- Advance high cell density Trench technology
- Low R_{DS(ON)} to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance

Application

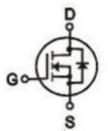
- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
200V	120mΩ	18A

TO-263 Pin Configuration





Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM18N20H	AGM18N20H	TO-263			800

Table 1. Absolute Maximum Ratings (TA=25℃)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	200	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(Tc=25℃) (Note 1)	18	А
	Drain Current-Continuous(Tc=100℃)		А
IDM (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 2)	72	А
PD	Maximum Power Dissipation(Tc=25℃)	158	W
	Maximum Power Dissipation(Tc=100℃)	63	w
EAS	EAS Avalanche energy (Note 3)		mJ
TJ,TSTG Operating Junction and Storage Temperature Range		-55 To 150	$^{\circ}$

Table 2. Thermal Characteristic

Symbol	Parameter	Тур	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹		62.5	°C/W
RθJC	Thermal Resistance Junction-Case ¹		0.79	°C/W



Table 3. Electrical Characteristics (TA=25 ℃ unless otherwise noted)

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
On/Off St	ates					
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	200			V
IDSS	Zero Gate Voltage Drain Current	VDS=200V,VGS=0V			1	μΑ
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V			±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	2.0		4.0	V
gFS	Forward Transconductance	VDS=10V,ID=9A				S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=9A		120	150	mΩ
		VGS=4.5V, ID=7A				mΩ
Dynamic	Characteristics					
Ciss	Input Capacitance	VDS=25V,VGS=0V,		882		pF
Coss	Output Capacitance	F=1MHZ		166		pF
Crss	Reverse Transfer Capacitance			91		pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz				Ω
Switching	Times					
td(on)	Turn-on Delay Time			38.5		nS
tr	Turn-on Rise Time	VGS=25V,VDS=100V		47		nS
td(off)	Turn-Off Delay Time	ID=18A,RGEN=25Ω		245		nS
tf	Turn-Off Fall Time			70		nS
Qg	Total Gate Charge			56		nC
Qgs	Gate-Source Charge	VGS=10V, VDS=160V, ID=18A		6.0		nC
Qgd	Gate-Drain Charge	- 15-10/		30		nC
Source-D	rain Diode Characteristics					
ISD	Source-Drain Current(Body Diode)				18	Α
VSD	Forward on Voltage	VGS=0V,IS=9A			1.4	V
trr	Reverse Recovery Time	IS=18A , dl/dt=500A/µs ,		182		ns
Qrr	Reverse Recovery Charge	TJ=25℃		1.27		nc

Notes 1. The maximum current rating is package limited.

Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

Notes 3.EAS condition: TJ=25 $^{\circ}\mathrm{C}$



Typical Characteristics $T_J = 25$ C, unless otherwise noted

Figure 1. Output Characteristics (T_J = 25°C)

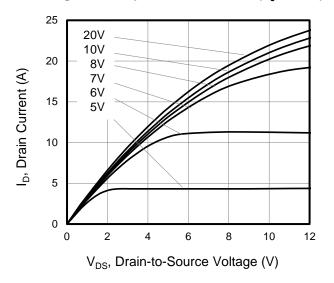


Figure 3. Drain Current vs. Temperature

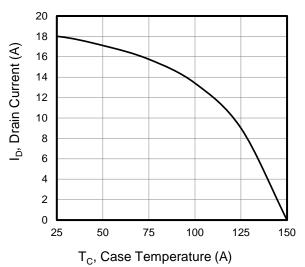


Figure 5. Transfer Characteristics

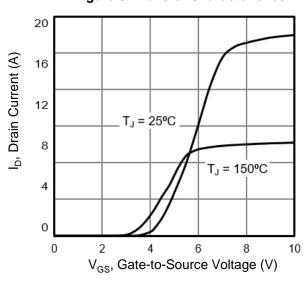


Figure 2. Body Diode Forward Voltage

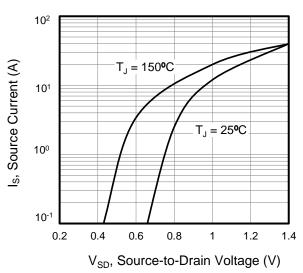


Figure 4. BV_{DSS} Variation vs. Temperature

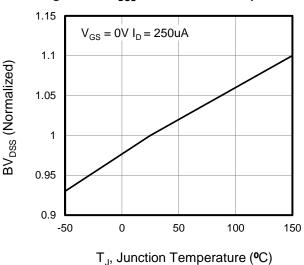
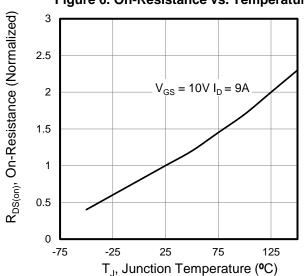


Figure 6. On-Resistance vs. Temperature





Typical Characteristics $T_J = 25^{\circ}\text{C}$, unless otherwise noted

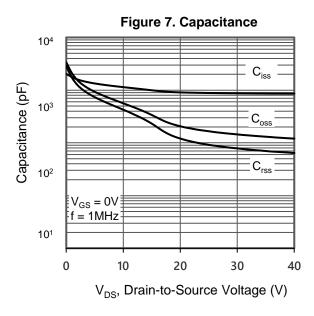


Figure 8. Gate Charge 10 $V_{DD} = 40V$ V_{GS}, Gate-to-Source Voltage (V) $V_{DD} = 100$ V 8 $V_{DD} = 160\overline{V}$ 6 4 2 0 0 10 20 30 40 50 60 Q_g, Total Gate Charge (nC)

Figure 9. Transient Thermal Impedance

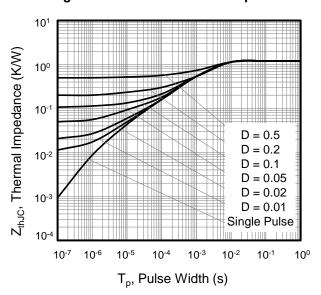




Figure A: Gate Charge Test Circuit and Waveform

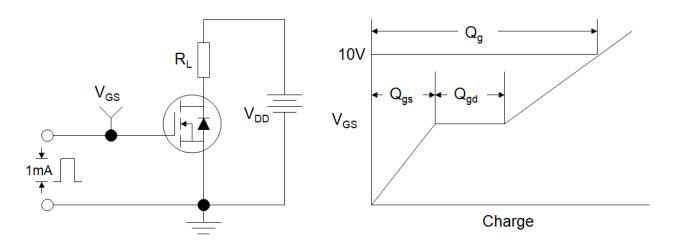


Figure B: Resistive Switching Test Circuit and Waveform

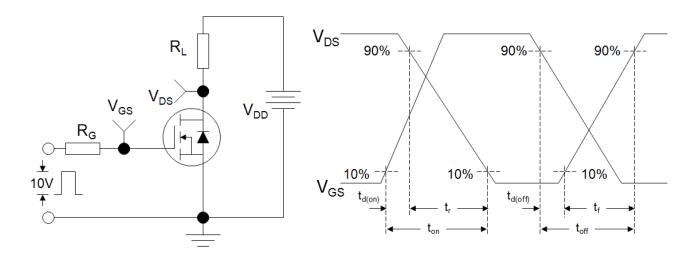
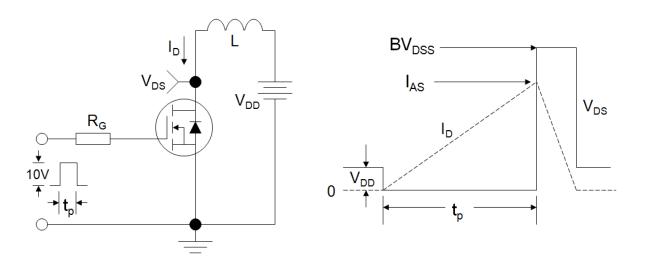
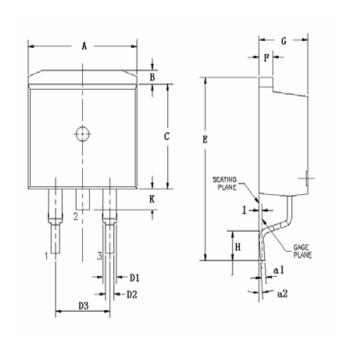


Figure C: Unclamped Inductive Switching Test Circuit and Waveform





TO-263 PACKAGE INFORMATION



Dimentions in mm unless otherwise specified

Symbol	Min	Nom	Max
Α	9.66	9.97	10.28
В	1.02	1.17	1.32
С	8.59	9.00	9.40
D1	1.14	1.27	1.40
D2	0.70	0.83	0.95
D3		5.08	
Е	15.09	15.24	15.39
F	1.15	1.28	1.40
G	4.30	4.50	4.70
Н	2.29	2.54	2.79
1		0.25	
K	1.30	1.45	1.60
a1	0.45	0.55	0.65
a2(degree)	0°		8°



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